

L Number	Hits	Search Text	DB	Time stamp
3	5	118/715-733.ccls. and ((wafer substrate) with (carrier holder) with (attach\$3 secur\$3) with spindle)	USPAT; US-PPGPUB	2003/06/09 09:05
4	330	118/715-733.ccls. and ((wafer substrate) with (carrier holder) with (attach\$3 secur\$3))	USPAT; US-PPGPUB	2003/06/09 09:09
10	62	118/715.ccls. and ((wafer substrate) with (carrier holder) with (attach\$3 secur\$3))	USPAT; US-PPGPUB	2003/06/09 09:09
-	343	118/715-733.ccls. and ((liner shutter shield) with (cylinder cylindrical\$3))	USPAT; US-PPGPUB	2003/06/09 08:43
-	271	118/715-733.ccls. and ((liner shutter shield) with (cool\$3))	USPAT; US-PPGPUB	2003/06/08 16:02
-	263	118/715-733.ccls. and ((liner shutter shield) with (reactor chamber)) and applica.us.	USPAT; US-PPGPUB	2003/06/08 15:07
-	39	118/715-733.ccls. and ((liner shutter shield) with (reactor chamber) with (annular cylindrical\$ cylinder)) and applica.us.	USPAT; US-PPGPUB	2003/06/08 15:15
-	174	((118/715-733.ccls. and ((liner shutter shield) with (reactor chamber)) and applica.us.) not (118/715-733.ccls. and ((liner shutter shield) with (reactor chamber) with (annular cylindrical\$ cylinder) and applica.us.))	USPAT; US-PPGPUB	2003/06/08 15:25
-	12	((US-6137121-\$ or US-61301541-\$ or US-61321117-\$ or US-61321117-\$ or US-61351117-\$ or US-61351117-\$ or US-61351774-\$ or US-61351774-\$ or US-6143083-\$ or US-6143083-\$ or US-6143083-\$ or US-6143083-\$).did.) and cool	USPAT	2003/06/08 15:32
-	4	((US-6137121-\$ or US-61301541-\$ or US-61321117-\$ or US-61321117-\$ or US-61351117-\$ or US-61351117-\$ or US-61351774-\$ or US-61351774-\$ or US-6143083-\$ or US-6143083-\$ or US-6143083-\$ or US-6143083-\$).did.) and cool	USPAT; US-PPGPUB	2003/06/08 15:32
-	8	((US-6137121-\$ or US-61301541-\$ or US-61321117-\$ or US-61321117-\$ or US-61351117-\$ or US-61351117-\$ or US-61351774-\$ or US-61351774-\$ or US-6143083-\$ or US-6143083-\$ or US-6143083-\$ or US-6143083-\$).did.) and cool	USPAT; US-PPGPUB	2003/06/08 15:32
-	28	53681122.JPHN.	USPAT	2003/06/08 15:56
-	15	53688743.JPHN. and cool\$3	USPAT; US-PPGPUB	2003/06/08 15:46
-	0	"14111163"	EPO; JPC; DEFVENT	2003/06/08 15:56
-	35747	((liner shutter shield) with (cool\$3 annular cylindrical\$ cylinder))	USPAT; US-PPGPUB	2003/06/08 16:06
-	6284	c23c164.ipc.	USPAT; US-PPGPUB	2003/06/08 16:07
-	53026	h110211.ipc.	USPAT; US-PPGPUB	2003/06/08 16:07
-	5463	(deposi.t\$3 etch\$3 "cni" layer film) same ((liner shutter shield) with (cool\$3 annular cylindrical\$ cylinder))	USPAT; US-PPGPUB	2003/06/08 16:06
-	0	(c23c164.ipc. h110211.ipc. ) and ((liner shutter shield) with (cool\$3) with (annular cylindrical\$ cylinder))	EPO; JPC; DEFVENT	2003/06/08 16:06
-	0	(c23c164.ipc. h110211.ipc. ) and ((liner shutter shield) with (cool\$3) with (annular cylindrical\$ cylinder))	EPO; JPC; DEFVENT	2003/06/08 16:06
-	48231	(c23c164.ipc. ) and ((liner shutter shield) same (cool\$3) same (annular cylindrical\$ cylinder))	EPO; JPC; DEFVENT	2003/06/08 16:07

-	742974	h0110.01\$.ipc.	EPO; JPO; DEFWENT	2003/06/08 18:08
-	34	(c23c:16\$.ipc. h011021\$.ipc. ) and ((liner shutter shield) same (cool\$3) same (annular cylindrical\$ cylinder))	EPO; JPO; DEFWENT	2003/06/08 16:07
-	0	200200:69970.URPN.	USPAT	2003/06/08 16:31
-	1	("6111:55").PN.	USPAT;	2003/06/08 17:26
-	1	("6111:25").PN.	USPAT;	2003/06/08 17:26
-	15	h011031\$.ipc. and (reactor with "stainless steel")	US-PGPUB	2003/06/08 17:28
-	634	h0110_1\$.ipc. and ((multiple plural\$3) with (wafer substrate, with carrier)	EPO; JPO; DEFWENT	2003/06/08 18:10
-	84	118/718.cc1s. and ((multiple plural\$3) with (wafer substrate, with holder)	USPAT;	2003/06/08 18:15
-	42	118/718.cc1s. and ((multiple plural\$3) with (wafer substrate, with carrier)	USPAT;	2003/06/08 18:11
-	6	118/718.cc1s. and ((multiple plural\$3) with (wafer substrate, with holder) and 118/719.cc1s.	US-PGPUB	2003/06/08 18:16
-	84	((multiple plural\$3) with (wafer substrate) with holder) and 118/719.cc1s.	USPAT;	2003/06/08 18:16
-	24	((multiple plural\$3) with (wafer substrate) with holder with (transfer\$4 transport\$3)) and 118/719.cc1s.	US-PGPUB	2003/06/08 18:17
-	35	118/718-733.cc1s. and ((wafer substrate) with (holder) with (secur\$3 attach\$3) with (spindle rctat\$3))	USPAT;	2003/06/08 18:30
-			US-PGPUB	